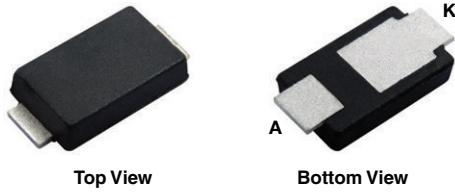


## Surface-Mount ESD Capability Rectifiers

### eSMP® Series


**SMPA (DO-221BC)**

Anode  Cathode

### FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Not recommended for PCB bottom side wave mounting
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	5.0 A
$V_{RRM}$	100 V, 200 V, 400 V, 600 V
$I_{FSM}$	42 A
$V_F$ at $I_F = 5.0$ A ( $T_A = 125$ °C)	0.95 V
$I_R$	10 $\mu$ A
$T_J$ max.	175 °C
Package	SMPA (DO-221BC)
Circuit configuration	Single

### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

### MECHANICAL DATA

**Case:** SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes the cathode end

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	SE50PAB	SE50PAD	SE50PAG	SE50PAJ	UNIT
Device marking code		50B	50D	50G	50J	
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	200	400	600	V
Maximum DC forward current	$I_F$ <sup>(1)</sup>	5.0				A
	$I_F$ <sup>(2)</sup>	1.6				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	42				A
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +175				°C

**Notes**

(1) Mounted on 30 mm x 30 mm pad areas, aluminum PCB

(2) Free air, mounted on recommended copper pad area

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	$I_F = 2.5 \text{ A}$	$T_A = 25^\circ\text{C}$	V <sub>F</sub> <sup>(1)</sup>	0.94	-	V	
	$I_F = 5.0 \text{ A}$			1.03	1.16		
	$I_F = 2.5 \text{ A}$	$T_A = 125^\circ\text{C}$		0.84	-		
	$I_F = 5.0 \text{ A}$			0.95	1.10		
Reverse current	Rated $V_R$	$T_A = 25^\circ\text{C}$	I <sub>R</sub> <sup>(2)</sup>	-	10	$\mu\text{A}$	
		$T_A = 125^\circ\text{C}$		13	150		
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	$t_{rr}$		2.0	-	$\mu\text{s}$	
Typical junction capacitance	4.0 V, 1 MHz	$C_J$		32	-	pF	

**Notes**

(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq 40 \text{ ms}$

**THERMAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

PARAMETER	SYMBOL	SE50PAB	SE50PAD	SE50PAG	SE50PAJ	UNIT
Typical thermal resistance	$R_{\theta JA}$ <sup>(1)</sup>	115				$^\circ\text{C/W}$
	$R_{\theta JM}$ <sup>(2)</sup>	7				

**Notes**

(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

(2) Mounted on 30 mm x 30 mm pad areas aluminum PCB;  $R_{\theta JM}$  - junction to mount

**IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$	$V_C$	H3B	> 8 kV

**ORDERING INFORMATION** (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE50PAJ-M3/I	0.033	I	14 000	13" diameter plastic tape and reel
SE50PAJHM3/H <sup>(1)</sup>	0.033	H	3500	7" diameter plastic tape and reel
SE50PAJHM3/I <sup>(1)</sup>	0.033	I	14 000	13" diameter plastic tape and reel

**Note**

(1) AEC-Q101 qualified

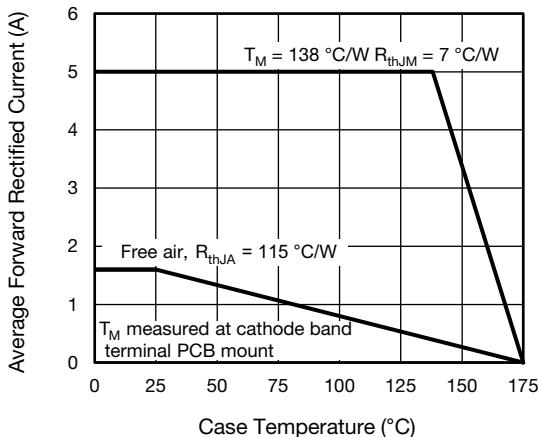
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

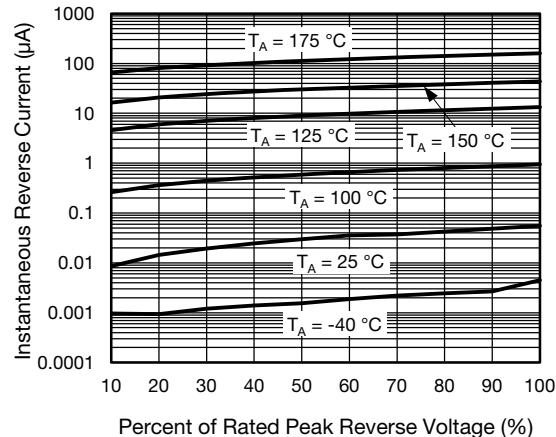


Fig. 4 - Typical Reverse Leakage Characteristics

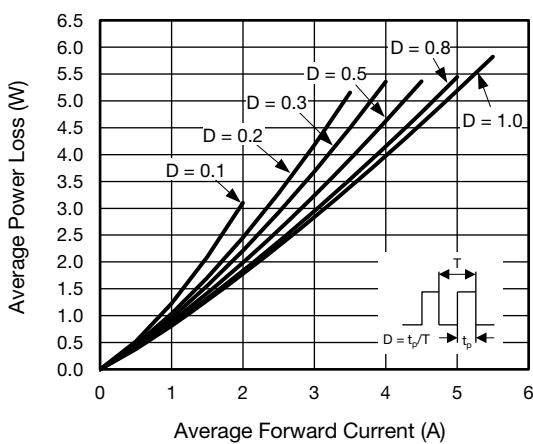


Fig. 2 - Forward Power Loss Characteristics

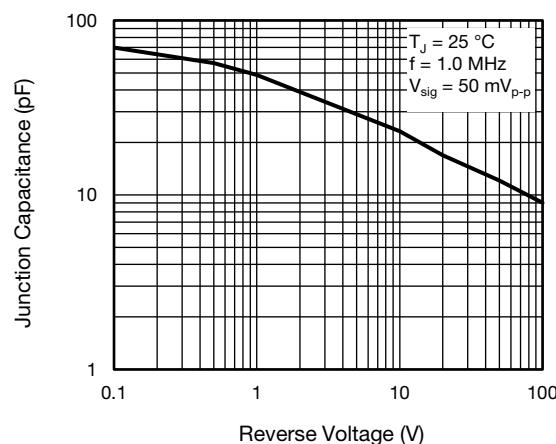


Fig. 5 - Typical Junction Capacitance

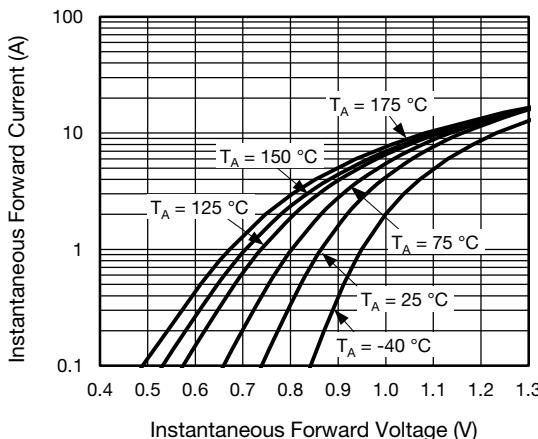


Fig. 3 - Typical Instantaneous Forward Characteristics

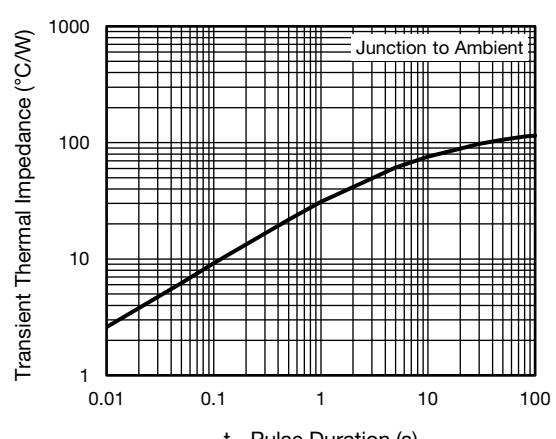
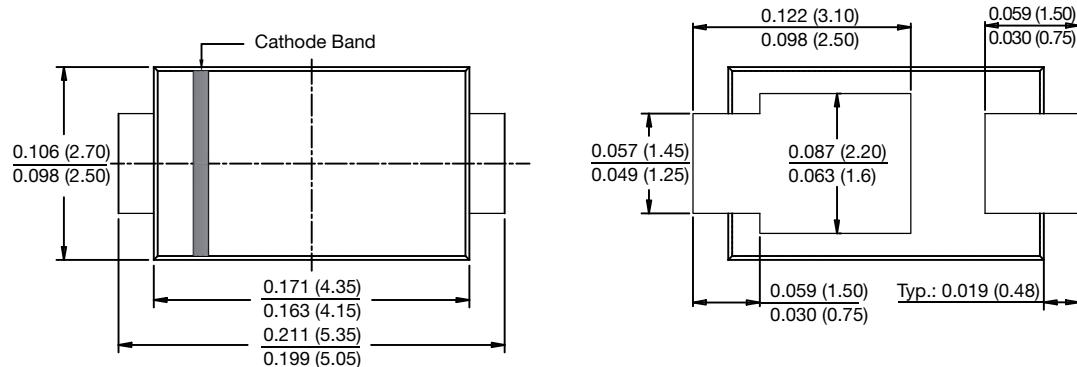
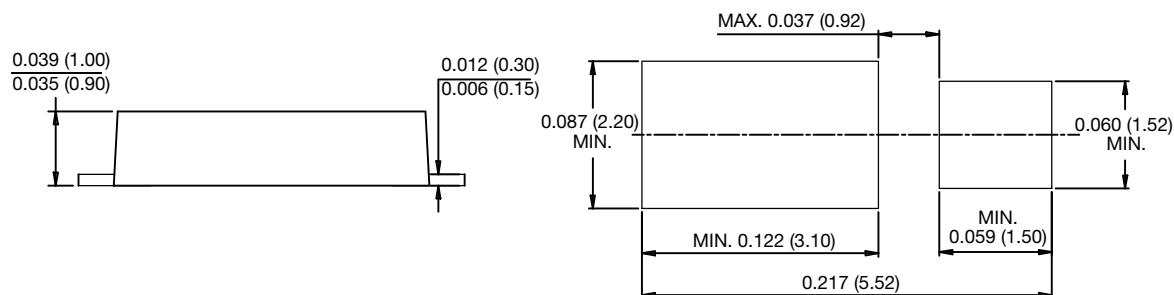


Fig. 6 - Typical Transient Thermal Impedances

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**SMPA (DO-221BC)**

**Mounting Pad Layout**


## Disclaimer

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